

## NOT RECOMMENDED FOR NEW DESIGN **USE AP1694AS-13**

**AP1694** 

#### OFFLINE. HIGH PF. HIGH EFFICIENCY DIMMABLE LED DRIVER CONTROLLER

## **Description**

The AP1694 is a high performance AC/DC power factor corrector for mains dimmable LED driver applications. The device uses Pulse Frequency Modulation (PFM) technology to regulate output current while achieving high power factor and low THD. It operates as a BCM (Boundary Conduction Mode) controller which is good for EMI.

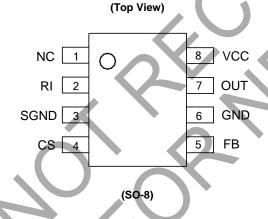
The AP1694 provides accurate constant current (CC) regulation while removing the opto-coupler and secondary control circuitry. It also eliminates the need of loop compensation circuitry while maintaining stability. It can meet the requirement of IEC6100-3-2 harmonic standard.

The AP1694 features low start-up current, low operation current. It adopts dynamic base driver control technology and valley on switching mode to achieve high efficiency. It also has rich protection features including over voltage, short circuit, over temperature protection.

The AP1694 provides the dimmable LED driver with a wide dimmer compatibility including leading edge and trailing edge dimmer. The AP1694 can achieve deep dimming down to 1%, while the dimming curve is compliant with the standard of NEMA SSL6.

The AP1694 is available in SO-8 package.

# **Pin Assignments**



### **Features**

- Primary Side Control for Output Current Regulation without Optocoupler
- Boundary Conduction Mode (BCM) Operation to Achieve Highefficiency
- High PF and Low THD
- High Efficiency without Dimmer
- Wide Range of Dimmer Compatibility
- Dimming Curve Compliant with NEMA SSL6
- Low Start-up Current
- Tight LED Current
- Tight LED Open Voltage
- **BJT Transistor Driver**
- Dynamic Base Driver Control
- Valley-mode Switching to Minimize the Transition Loss
- Easy EMI
- Internal Protections:
  - Under Voltage Lock Out (UVLO)
  - Leading-edge Blanking (LEB)
  - **Output Short Protection**
  - **Output Open Protection**
  - Over Temperature Protection
- Flexible for Design with Small Form Factor and Very Low BOM
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

## **Applications**

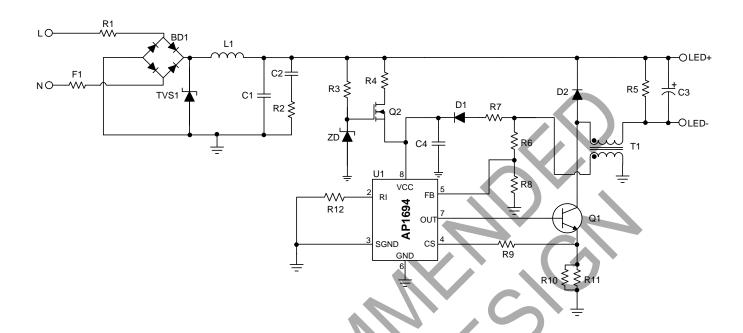
Mains Dimmable LED Lighting

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
  - 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



# **Typical Applications Circuit**

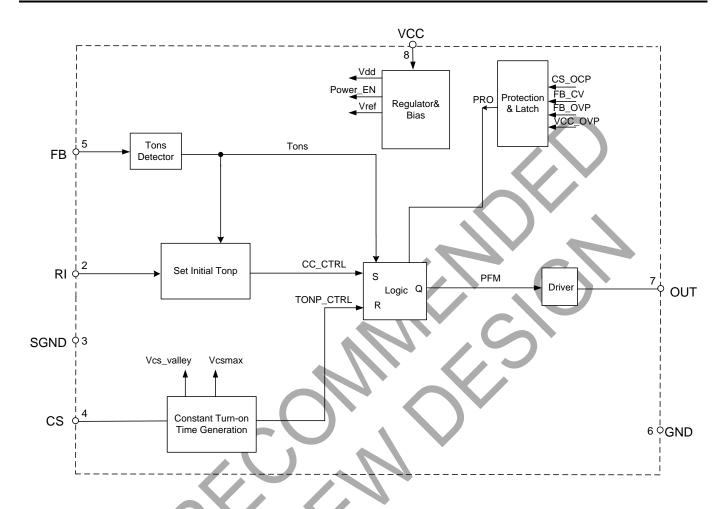


# **Pin Descriptions**

Pin Number	Pin Name	Function
1	NC	No connection.
2	RI	The initial on time setting resistor.
3	SGND	Must connect to GND.
4	CS	Primary current sensing.
5	FB	The feedback voltage from auxiliary winding
6	GND	Ground.
7	OUT	Gate driver output.
8	VCC	Supply voltage of gate driver and control circuits of the IC.



# **Functional Block Diagram**



# Absolute Maximum Ratings (Note 4) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameter	Rating	Unit
Vcc	Power Supply Voltage	-0.3 to 35	V
IOUT	Driver Output Current	150	mA
V <sub>CS</sub>	Voltage at CS to GND	-0.3 to 7	V
$V_{FB}$	FB Input Voltage	-40 to 10	V
T <sub>J</sub>	Operating Junction Temperature	-40 to +150	°C
T <sub>STG</sub>	Storage Temperature	-65 to +150	°C
T <sub>LEAD</sub>	Lead Temperature (Soldering, 10 sec)	+300	°C
P <sub>D</sub>	Power Dissipation (T <sub>A</sub> = +50°C)	0.65	W
$\theta_{JA}$	Thermal Resistance (Junction to Ambient)	160	°C/W
_	ESD (Human Body Model)	2000	V
<ul> <li>ESD (Charged-device Model)</li> </ul>		±1000	V

Note: 4. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.



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# **Recommended Operating Conditions**

Symbol	Parameter	Min	Max	Unit
V <sub>CC</sub>	Power Supply Voltage	7	25	V
T <sub>A</sub>	Ambient Temperature	-40	+105	°C

## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit		
UVLO Section								
V <sub>TH</sub> (ST)	Start-up Threshold –		13	14.5	16	V		
V <sub>OPR</sub> (Min)	Minimum Operating Voltage	After turn on	5.5	6.5	7.5	V		
V <sub>CC_OVP</sub>	VCC OVP Voltage	-	27	29	31	V		
_	VCC Delatch Voltage (Note 5)	-	3	4	5	V		
Standby Current Section								
Ist	Start-up Current	$V_{CC} = V_{TH} (ST) -0.5V$ , Before start up		-	20	μΑ		
I <sub>CC</sub> (OPR)	Operating Current	Static	-	900	1300	μΑ		
Drive Output Section		. 11						
l <sub>оит</sub>	Output Current (Note 5)	V <sub>CS_PEAK</sub> = 1V		_	60	mA		
Vos	UVLO Saturation Voltage	$V_{CC} = 0$ to $V_{CC-ON}$ , $I_{SINK} = 10mA$		_	1.1	V		
Current Sense Section								
V <sub>CS_REF</sub>	Current Sense Reference	-	-	1	_	V		
V <sub>CS_CLAMP</sub>	Current Sense Reference Clamp	-	1.2	1.4	-	V		
t <sub>ONP_MIN</sub>	Minimum t <sub>ONP</sub>	-	700	-	1000	ns		
t <sub>D(H-L)</sub>	Delay to Output (Note 5)	-	50	150	250	ns		
Feedback Input Section	=\(\cdot\)							
I <sub>FB</sub>	Feedback Pin Input Leakage Current	V <sub>FB</sub> = 2V	-	ı	4	μΑ		
V <sub>FB_CV</sub>	FB CV Threshold	_	3.8	4	4.2	٧		
V <sub>FB_OVP</sub>	FB OVP Threshold – 4.5		4.5	6	7.5	V		
Output Current								
_	System Output Current On Final Test Board	_	_	_	±2	%		
Over Temperature Protection Section								
4 -	Shutdown Temperature (Note 5)	-	+150	-	-	°C		
	Temperature Hysteresis (Note 5)	_	_	+20	_	°C		

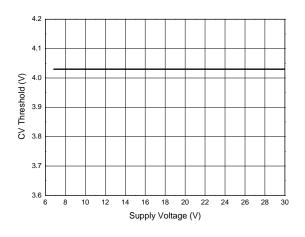
Note: 5. These parameters, although guaranteed by design, are not 100% tested in production.

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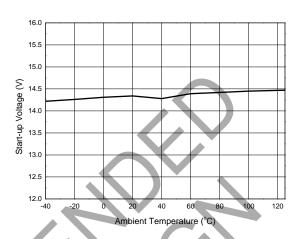


## **Performance Characteristics**

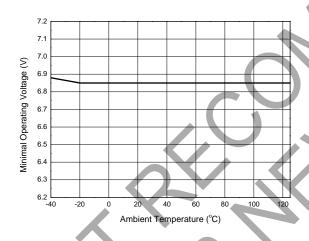
#### CV Threshold vs. Supply Voltage



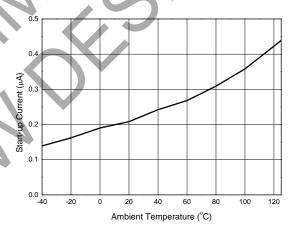
#### Start-up Voltage vs. Ambient Temperature



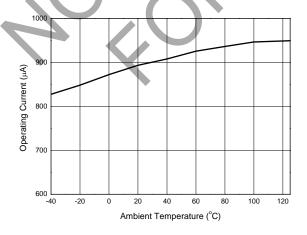
#### Minimal Operating Voltage vs. Ambient Temperature



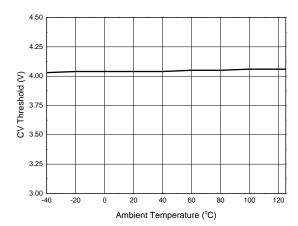
## Start-up Current vs. Ambient Temperature



## **Operating Current vs. Ambient Temperature**



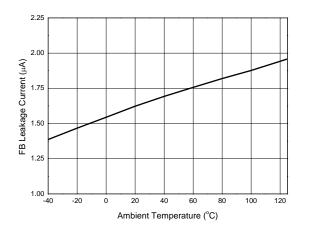
#### **CV Threshold vs. Ambient Temperature**



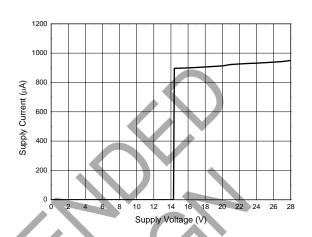


## **Performance Characteristics (Cont.)**

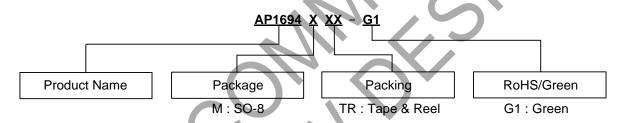
#### FB Leakage Current vs. Ambient Temperature



#### Supply Current vs. Supply Voltage

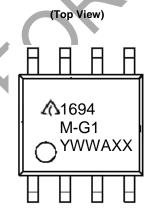


# **Ordering Information**



Package	Ambient Temperature Range	Part Number	Marking ID	Packing
SO-8	-40°C to +105°C	AP1694MTR-G1	1694M-G1	4000/13"Tape & Reel

# **Marking Information**



First and Second Lines: Logo and Marking ID

(See Ordering Information) Third Line: Date Code

Y: Year

WW: Work Week of Molding A: Assembly House Code XX: 7<sup>th</sup> and8<sup>th</sup> Digits of Batch No.

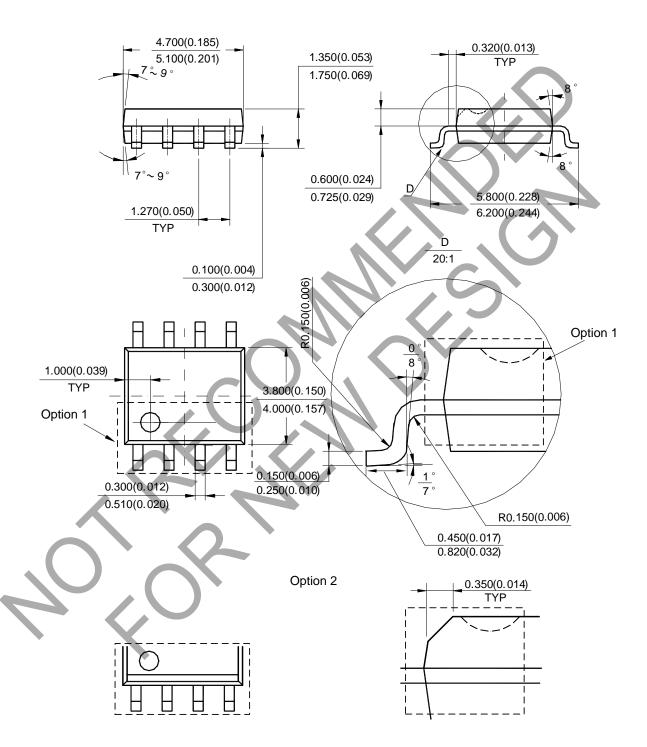
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# Package Outline Dimensions (All dimensions in mm (inch).)

#### (1) Package Type: SO-8

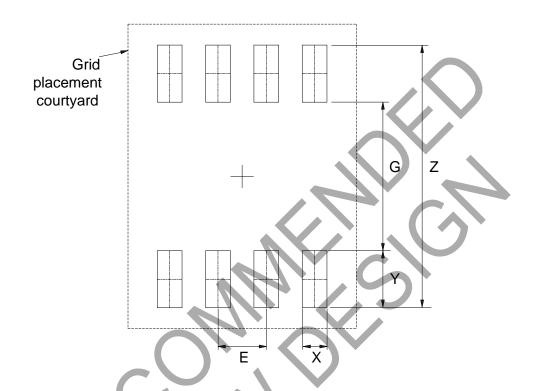


Note: Eject hole, oriented hole and mold mark is optional.



# **Suggested Pad Layout**

(1) Package Type: SO-8



Dimensions	Z	G	X	Y	E
Diriciolorio	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)
Value	6.900/0.272	3.900/0.154	0.650/0.026	1.500/0.059	1.270/0.050

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